

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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SURFACE MOUNT SILICON DUAL, COMMON CATHODE HIGH CURRENT, LOW  $V_F$  SCHOTTKY DIODE





www.centralsemi.com

## **DESCRIPTION:**

The CENTRAL SEMICONDUCTOR CMPSH05-4C is a dual, common cathode high current, low  $V_{\text{F}}$  40 volt Schottky diode pair packaged in a space saving SOT-23F surface mount case. This device has been designed for small signal general purpose applications when small size and operational efficiency are prime requirements.

**MARKING CODE: C405** 

#### **FEATURES:**

- Low V<sub>F</sub>=0.35V max @ 100mA
- V<sub>RRM</sub>=40V
- I<sub>F</sub>=500mA

MAXIMUM RATINGS: (T <sub>A</sub> =25°C)	SYMBOL		UNITS
Peak Repetitive Reverse Voltage	$V_{RRM}$	40	V
Continuous Forward Current	I <sub>F</sub>	500	mA
Peak Repetitive Forward Current, tp≤1.0ms	I <sub>FRM</sub>	3.5	Α
Peak Forward Surge Current, tp=8.0ms	I <sub>FSM</sub>	10	Α
Power Dissipation	$P_{D}$	350	mW
Operating and Storage Junction Temperature	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C
Thermal Resistance	$\Theta_{JA}$	357	°C/W

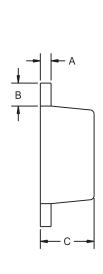
## ELECTRICAL CHARACTERISTICS PER DIODE: (T<sub>A</sub>=25°C unless otherwise noted)

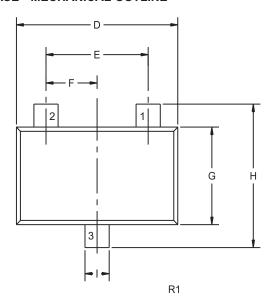
SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS
$I_{R}$	V <sub>R</sub> =10V		30	μΑ
$I_{R}$	V <sub>R</sub> =30V		100	μΑ
$BV_R$	I <sub>R</sub> =500μA	40		V
$V_{F}$	I <sub>F</sub> =100μA		0.13	V
$V_{F}$	I <sub>F</sub> =1.0mA		0.21	V
$V_{F}$	I <sub>F</sub> =10mA		0.27	V
$V_{F}$	I <sub>F</sub> =100mA		0.35	V
$V_{F}$	I <sub>F</sub> =500mA		0.47	V
CJ	$V_R$ =1.0 $V$ , f=1.0 $M$ Hz		50	pF

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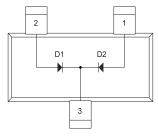


## **SOT-23F CASE - MECHANICAL OUTLINE**





## **PIN CONFIGURATION**



## LEAD CODE:

- 1) Anode D2
- 2) Anode D1
- 3) Cathode D1, D2

DIMENSIONS						
	INCHES		MILLIMETERS			
SYMBOL	MIN	MAX	MIN	MAX		
Α	0.004	0.008	0.10	0.20		
В	0.012	0.020	0.30	0.50		
С	0.031	0.039	0.80	1.00		
D	0.110	0.118	2.80	3.00		
E	0.075		1.90			
F	0.037		0.95			
G	0.059	0.067	1.50	1.70		
Н	0.091	0.098	2.30	2.50		
	0.014	0.018	0.35	0.45		
SOT-23F (REV: R1)						

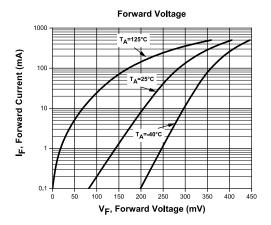
**MARKING CODE: C405** 

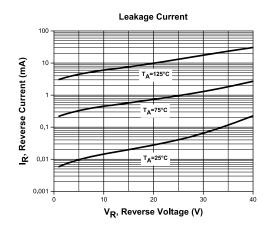
R3 (8-January 2018)

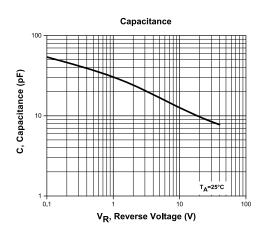
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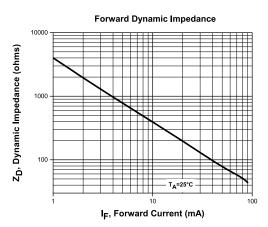


## TYPICAL ELECTRICAL CHARACTERISTICS





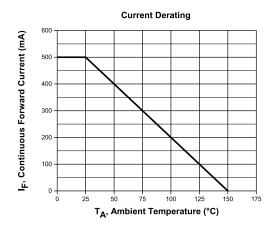


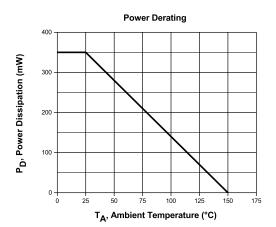


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## TYPICAL ELECTRICAL CHARACTERISTICS





#### **OUTSTANDING SUPPORT AND SUPERIOR SERVICES**



#### PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

#### **DESIGNER SUPPORT/SERVICES**

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2<sup>nd</sup> day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- · Special wafer diffusions
- PbSn plating options
- · Package details
- Application notes
- · Application and design sample kits
- Custom product and package development

#### REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

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